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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	5760
Number of Logic Elements/Cells	-
Total RAM Bits	2211840
Number of I/O	912
Number of Gates	4000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1517-BBGA, FCBGA
Supplier Device Package	1517-FCBGA (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v4000-4ffg1517i

Table 1: Virtex-II Field-Programmable Gate Array Family Members

Device	System Gates	CLB (1 CLB = 4 slices = Max 128 bits)			Multiplier Blocks	SelectRAM Blocks		DCMs	Max I/O Pads ⁽¹⁾
		Array Row x Col.	Slices	Maximum Distributed RAM Kbits		18 Kbit Blocks	Max RAM (Kbits)		
XC2V40	40K	8 x 8	256	8	4	4	72	4	88
XC2V80	80K	16 x 8	512	16	8	8	144	4	120
XC2V250	250K	24 x 16	1,536	48	24	24	432	8	200
XC2V500	500K	32 x 24	3,072	96	32	32	576	8	264
XC2V1000	1M	40 x 32	5,120	160	40	40	720	8	432
XC2V1500	1.5M	48 x 40	7,680	240	48	48	864	8	528
XC2V2000	2M	56 x 48	10,752	336	56	56	1,008	8	624
XC2V3000	3M	64 x 56	14,336	448	96	96	1,728	12	720
XC2V4000	4M	80 x 72	23,040	720	120	120	2,160	12	912
XC2V6000	6M	96 x 88	33,792	1,056	144	144	2,592	12	1,104
XC2V8000	8M	112 x 104	46,592	1,456	168	168	3,024	12	1,108

Notes:

1. See details in Table 2, "Maximum Number of User I/O Pads".

General Description

The Virtex-II family is a platform FPGA developed for high performance from low-density to high-density designs that are based on IP cores and customized modules. The family delivers complete solutions for telecommunication, wireless, networking, video, and DSP applications, including PCI, LVDS, and DDR interfaces.

The leading-edge 0.15 μm / 0.12 μm CMOS 8-layer metal process and the Virtex-II architecture are optimized for high speed with low power consumption. Combining a wide variety of flexible features and a large range of densities up to 10 million system gates, the Virtex-II family enhances programmable logic design capabilities and is a powerful alternative to mask-programmed gates arrays. As shown in Table 1, the Virtex-II family comprises 11 members, ranging from 40K to 8M system gates.

Packaging

Offerings include ball grid array (BGA) packages with 0.80 mm, 1.00 mm, and 1.27 mm pitches. In addition to traditional wire-bond interconnects, flip-chip interconnect is used in some of the BGA offerings. The use of flip-chip interconnect offers more I/Os than is possible in wire-bond versions of the similar packages. Flip-chip construction offers the combination of high pin count with high thermal capacity.

Wire-bond packages CS, FG, and BG are optionally available in Pb-free versions CSG, FGG, and BGG. See [Virtex-II Ordering Examples, page 6](#).

Table 2 shows the maximum number of user I/Os available. The Virtex-II device/package combination table (Table 6 at the end of this section) details the maximum number of I/Os for each device and package using wire-bond or flip-chip technology.

Table 2: Maximum Number of User I/O Pads

Device	Wire-Bond	Flip-Chip
XC2V40	88	-
XC2V80	120	-
XC2V250	200	-
XC2V500	264	-
XC2V1000	328	432
XC2V1500	392	528
XC2V2000	-	624
XC2V3000	516	720
XC2V4000	-	912
XC2V6000	-	1,104
XC2V8000	-	1,108

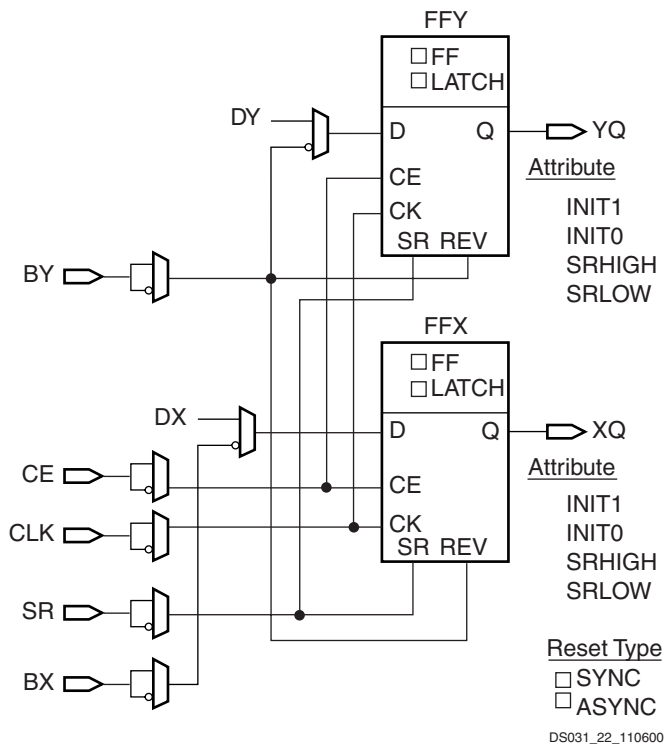


Figure 17: Register / Latch Configuration in a Slice

The set and reset functionality of a register or a latch can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset has precedence over a set, and an asynchronous clear has precedence over a preset.

Distributed SelectRAM Memory

Each function generator (LUT) can implement a 16 x 1-bit synchronous RAM resource called a distributed SelectRAM element. The SelectRAM elements are configurable within a CLB to implement the following:

- Single-Port 16 x 8 bit RAM
- Single-Port 32 x 4 bit RAM
- Single-Port 64 x 2 bit RAM
- Single-Port 128 x 1 bit RAM
- Dual-Port 16 x 4 bit RAM
- Dual-Port 32 x 2 bit RAM
- Dual-Port 64 x 1 bit RAM

Distributed SelectRAM memory modules are synchronous (write) resources. The combinatorial read access time is extremely fast, while the synchronous write simplifies high-speed designs. A synchronous read can be implemented with a storage element in the same slice. The distributed SelectRAM memory and the storage element share the same clock input. A Write Enable (WE) input is active High, and is driven by the SR input.

Table 9 shows the number of LUTs (2 per slice) occupied by each distributed SelectRAM configuration.

Table 9: Distributed SelectRAM Configurations

RAM	Number of LUTs
16 x 1S	1
16 x 1D	2
32 x 1S	2
32 x 1D	4
64 x 1S	4
64 x 1D	8
128 x 1S	8

Notes:

1. S = single-port configuration; D = dual-port configuration

For single-port configurations, distributed SelectRAM memory has one address port for synchronous writes and asynchronous reads.

For dual-port configurations, distributed SelectRAM memory has one port for synchronous writes and asynchronous reads and another port for asynchronous reads. The function generator (LUT) has separated read address inputs (A1, A2, A3, A4) and write address inputs (WG1/WF1, WG2/WF2, WG3/WF3, WG4/WF4).

In single-port mode, read and write addresses share the same address bus. In dual-port mode, one function generator (R/W port) is connected with shared read and write addresses. The second function generator has the A inputs (read) connected to the second read-only port address and the W inputs (write) shared with the first read/write port address.

Figure 18, Figure 19, and Figure 20 illustrate various example configurations.

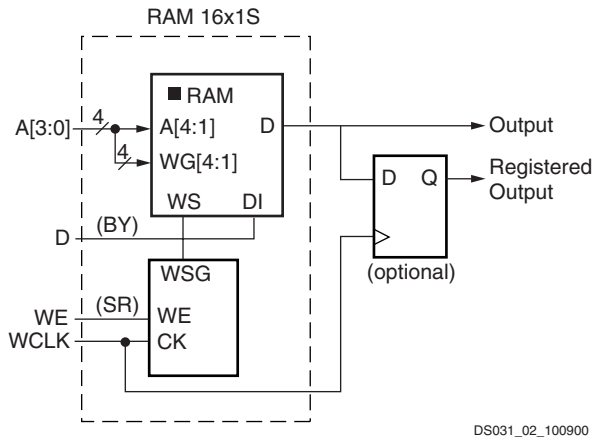


Figure 18: Distributed SelectRAM (RAM16x1S)

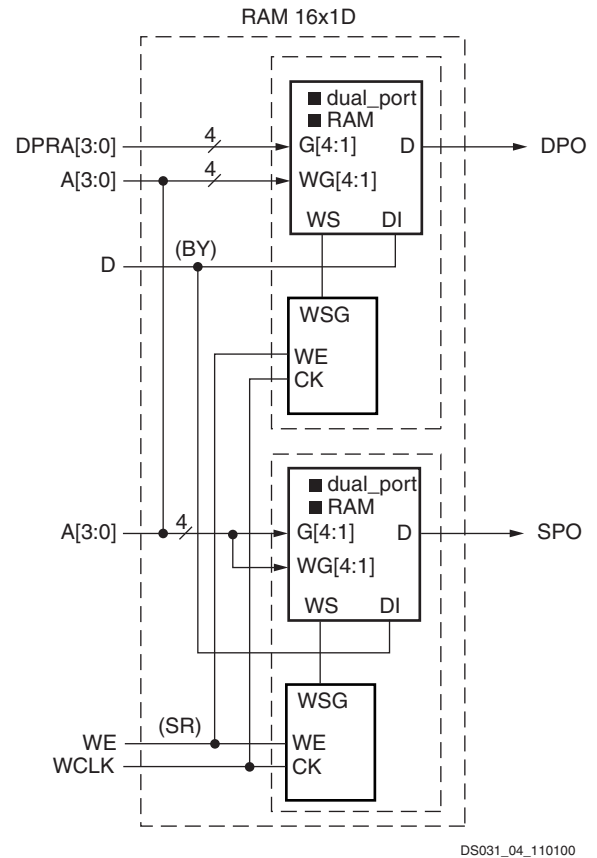


Figure 20: Dual-Port Distributed SelectRAM (RAM16x1D)

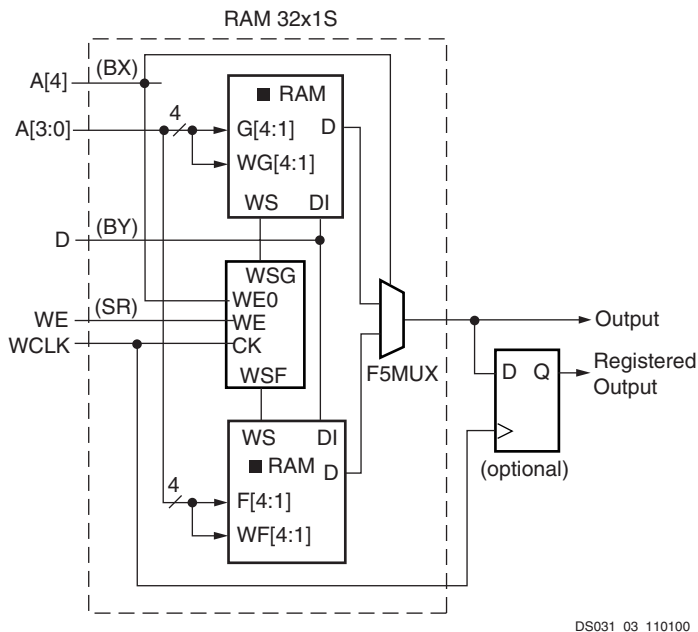


Figure 19: Single-Port Distributed SelectRAM (RAM32x1S)

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 10 shows the number of LUTs occupied by each configuration.

Table 10: ROM Configuration

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

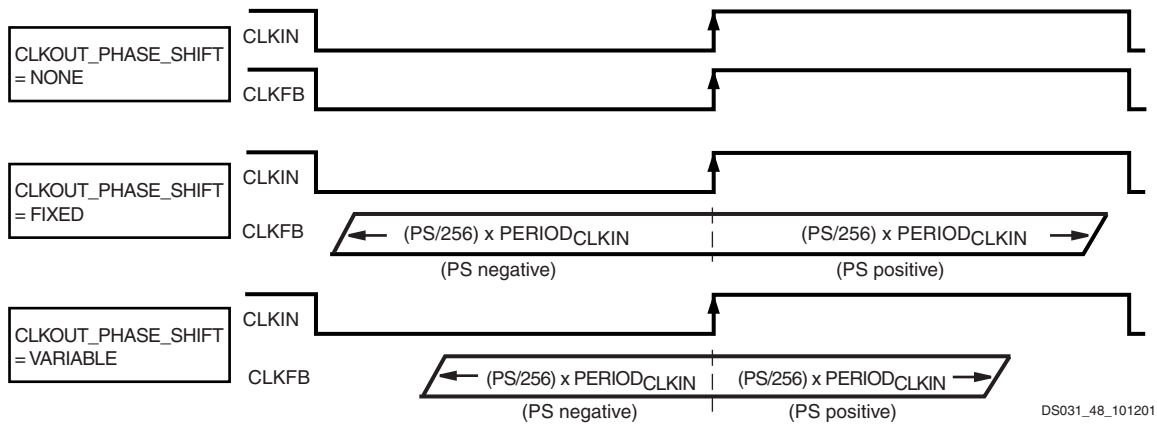


Figure 46: Fine-Phase Shifting Effects

Table 22 lists fine-phase shifting control pins, when used in variable mode.

Table 22: Fine-Phase Shifting Control Pins

Control Pin	Direction	Function
PSINCDEC	in	Increment or decrement
PSEN	in	Enable $\pm$ phase shift
PSCLK	in	Clock for phase shift
PSDONE	out	Active when completed

Two separate components of the phase shift range must be understood:

- PHASE_SHIFT attribute range
- FINE_SHIFT_RANGE DCM timing parameter range

The PHASE_SHIFT attribute is the numerator in the following equation:

$$\text{Phase Shift (ns)} = (\text{PHASE_SHIFT}/256) * \text{PERIOD}_{\text{CLKIN}}$$

The full range of this attribute is always -255 to +255, but its practical range varies with CLKIN frequency, as constrained by the FINE_SHIFT_RANGE component, which represents the total delay achievable by the phase shift delay line. Total delay is a function of the number of delay taps used in the circuit. Across process, voltage, and temperature, this absolute range is guaranteed to be as specified under **DCM Timing Parameters** in Module 3.

Absolute range (fixed mode) = $\pm$ FINE_SHIFT_RANGE

Absolute range (variable mode) = $\pm$ FINE_SHIFT_RANGE/2

Table 23: DCM Frequency Ranges

Output Clock	Low-Frequency Mode		High-Frequency Mode	
	CLKIN Input	CLK Output	CLKIN Input	CLK Output
CLK0, CLK180	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_1X_LF	CLKIN_FREQ_DLL_HF	CLKOUT_FREQ_1X_HF
CLK90, CLK270	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_1X_LF	NA	NA
CLK2X, CLK2X180	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_2X_LF	NA	NA
CLKDV	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_DV_LF	CLKIN_FREQ_DLL_HF	CLKOUT_FREQ_DV_HF
CLKFX, CLKFX180	CLKIN_FREQ_FX_LF	CLKOUT_FREQ_FX_LF	CLKIN_FREQ_FX_HF	CLKOUT_FREQ_FX_HF

The reason for the difference between fixed and variable modes is as follows. For variable mode to allow symmetric, dynamic sweeps from -255/256 to +255/256, the DCM sets the "zero phase skew" point as the middle of the delay line, thus dividing the total delay line range in half. In fixed mode, since the PHASE_SHIFT value never changes after configuration, the entire delay line is available for insertion into either the CLKIN or CLKFB path (to create either positive or negative skew).

Taking both of these components into consideration, the following are some usage examples:

- If $\text{PERIOD}_{\text{CLKIN}} = 2 * \text{FINE_SHIFT_RANGE}$, then PHASE_SHIFT in fixed mode is limited to ± 128 , and in variable mode it is limited to ± 64 .
- If $\text{PERIOD}_{\text{CLKIN}} = \text{FINE_SHIFT_RANGE}$, then PHASE_SHIFT in fixed mode is limited to ± 255 , and in variable mode it is limited to ± 128 .
- If $\text{PERIOD}_{\text{CLKIN}} \leq 0.5 * \text{FINE_SHIFT_RANGE}$, then PHASE_SHIFT is limited to ± 255 in either mode.

Operating Modes

The frequency ranges of DCM input and output clocks depend on the operating mode specified, either low-frequency mode or high-frequency mode, according to Table 23. (For actual values, see **Virtex-II Switching Characteristics** in Module 3). The CLK2X, CLK2X180, CLK90, and CLK270 outputs are not available in high-frequency mode.

High or low-frequency mode is selected by an attribute.

Table 25: Pipelined Multiplier Switching Characteristics

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Setup and Hold Times Before/After Clock					
Data Inputs	T _{MULIDCK} /T _{MULCKID}	3.00/ 0.00	3.45/ 0.00	3.89/ 0.00	ns, Max
Clock Enable	T _{MULIDCK_CE} /T _{MULCKID_CE}	0.72/ 0.00	0.80/ 0.00	0.86/ 0.00	ns, Max
Reset	T _{MULIDCK_RST} /T _{MULCKID_RST}	0.72/ 0.00	0.80/ 0.00	0.86/ 0.00	ns, Max
Clock to Output Pin					
Clock to Pin 35	T _{MULTCK_P35}	3.05	6.91	8.12	ns, Max
Clock to Pin 34	T _{MULTCK_P34}	2.95	6.75	7.93	ns, Max
Clock to Pin 33	T _{MULTCK_P33}	2.85	6.59	7.74	ns, Max
Clock to Pin 32	T _{MULTCK_P32}	2.76	6.43	7.56	ns, Max
Clock to Pin 31	T _{MULTCK_P31}	2.66	6.27	7.37	ns, Max
Clock to Pin 30	T _{MULTCK_P30}	2.56	6.11	7.19	ns, Max
Clock to Pin 29	T _{MULTCK_P29}	2.47	5.95	7.00	ns, Max
Clock to Pin 28	T _{MULTCK_P28}	2.37	5.79	6.81	ns, Max
Clock to Pin 27	T _{MULTCK_P27}	2.27	5.63	6.63	ns, Max
Clock to Pin 26	T _{MULTCK_P26}	2.17	5.47	6.44	ns, Max
Clock to Pin 25	T _{MULTCK_P25}	2.08	5.31	6.26	ns, Max
Clock to Pin 24	T _{MULTCK_P24}	1.98	5.15	6.07	ns, Max
Clock to Pin 23	T _{MULTCK_P23}	1.88	4.99	5.88	ns, Max
Clock to Pin 22	T _{MULTCK_P22}	1.79	4.83	5.70	ns, Max
Clock to Pin 21	T _{MULTCK_P21}	1.69	4.67	5.51	ns, Max
Clock to Pin 20	T _{MULTCK_P20}	1.59	4.51	5.33	ns, Max
Clock to Pin 19	T _{MULTCK_P19}	1.50	4.35	5.14	ns, Max
Clock to Pin 18	T _{MULTCK_P18}	1.40	4.19	4.95	ns, Max
Clock to Pin 17	T _{MULTCK_P17}	1.30	4.03	4.77	ns, Max
Clock to Pin 16	T _{MULTCK_P16}	1.20	3.87	4.58	ns, Max
Clock to Pin 15	T _{MULTCK_P15}	1.11	3.71	4.40	ns, Max
Clock to Pin 14	T _{MULTCK_P14}	1.01	3.55	4.21	ns, Max
Clock to Pin 13	T _{MULTCK_P13}	0.91	3.39	4.02	ns, Max
Clock to Pin 12	T _{MULTCK_P12}	0.91	3.23	3.84	ns, Max
Clock to Pin 11	T _{MULTCK_P11}	0.91	3.07	3.65	ns, Max
Clock to Pin 10	T _{MULTCK_P10}	0.91	2.91	3.47	ns, Max
Clock to Pin 9	T _{MULTCK_P9}	0.91	2.75	3.28	ns, Max
Clock to Pin 8	T _{MULTCK_P8}	0.91	2.59	3.09	ns, Max
Clock to Pin 7	T _{MULTCK_P7}	0.91	2.43	2.91	ns, Max
Clock to Pin 6	T _{MULTCK_P6}	0.91	2.27	2.72	ns, Max
Clock to Pin 5	T _{MULTCK_P5}	0.91	2.11	2.54	ns, Max
Clock to Pin 4	T _{MULTCK_P4}	0.91	1.95	2.35	ns, Max
Clock to Pin 3	T _{MULTCK_P3}	0.91	1.79	2.16	ns, Max
Clock to Pin 2	T _{MULTCK_P2}	0.91	1.63	1.98	ns, Max
Clock to Pin 1	T _{MULTCK_P1}	0.91	1.47	1.79	ns, Max
Clock to Pin 0	T _{MULTCK_P0}	0.91	1.31	1.61	ns, Max

Virtex-II Pin-to-Pin Input Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

Global Clock Setup and Hold for LVTTTL Standard, *With DCM*

Table 36: Global Clock Setup and Hold for LVTTTL Standard, *With DCM*

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
Input Setup and Hold Time Relative to Global Clock Input Signal for LVTTTL Standard. For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11 .						
No Delay Global Clock and IFF with DCM	T_{PSDCM}/T_{PHDCM}	XC2V40	1.60/−0.90	1.60/−0.90	1.84/−0.76	ns
		XC2V80	1.60/−0.90	1.60/−0.90	1.84/−0.76	ns
		XC2V250	1.60/−0.90	1.60/−0.90	1.84/−0.76	ns
		XC2V500	1.60/−0.90	1.60/−0.90	1.84/−0.76	ns
		XC2V1000	1.60/−0.90	1.60/−0.90	1.84/−0.76	ns
		XC2V1500	1.60/−0.90	1.60/−0.90	1.84/−0.76	ns
		XC2V2000	1.70/−0.90	1.70/−0.90	1.96/−0.76	ns
		XC2V3000	1.70/−0.90	1.70/−0.90	1.96/−0.76	ns
		XC2V4000	1.70/−0.90	1.70/−0.90	1.96/−0.76	ns
		XC2V6000	1.70/−0.90	1.70/−0.90	1.96/−0.76	ns
		XC2V8000		1.70/−0.90	1.96/−0.76	ns

Notes:

1. IFF = Input Flip-Flop or Latch
2. Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
3	IO_L96N_3	J16		
3	IO_L96P_3	J15		
3	IO_L94N_3	J14		
3	IO_L94P_3	J13		
3	IO_L93N_3/VREF_3	K16	NC	
3	IO_L93P_3	K15	NC	
3	IO_L91N_3	K14	NC	
3	IO_L91P_3	K13	NC	
3	IO_L45N_3/VREF_3	K12	NC	NC
3	IO_L45P_3	L12	NC	NC
3	IO_L43N_3	L16	NC	NC
3	IO_L43P_3	L15	NC	NC
3	IO_L06N_3	L14	NC	
3	IO_L06P_3	L13	NC	
3	IO_L04N_3	M16	NC	
3	IO_L04P_3	M15	NC	
3	IO_L03N_3/VREF_3	M14		
3	IO_L03P_3	M13		
3	IO_L02N_3/VRP_3	N15		
3	IO_L02P_3/VRN_3	N14		
3	IO_L01N_3	N16		
3	IO_L01P_3	P16		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	T14		
4	IO_L01P_4/INIT_B	T13		
4	IO_L02N_4/D0/DIN ⁽¹⁾	P13		
4	IO_L02P_4/D1	R13		
4	IO_L03N_4/D2/ALT_VRP_4	N12		
4	IO_L03P_4/D3/ALT_VRN_4	P12		
4	IO_L04N_4/VREF_4	R12	NC	NC
4	IO_L04P_4	T12	NC	NC
4	IO_L05N_4/VRP_4	N11	NC	NC
4	IO_L05P_4/VRN_4	P11	NC	NC

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
6	VCCO_6	J5		
7	VCCO_7	H6		
7	VCCO_7	H5		
7	VCCO_7	G6		
NA	CCLK	P15		
NA	PROG_B	A2		
NA	DONE	R14		
NA	M0	T2		
NA	M1	P2		
NA	M2	R3		
NA	HSWAP_EN	B3		
NA	TCK	A15		
NA	TDI	C2		
NA	TDO	C15		
NA	TMS	B14		
NA	PWRDWN_B	T15		
NA	RSVD	A4		
NA	RSVD	A3		
NA	VBATT	A14		
NA	RSVD	A13		
NA	VCCAUX	R16		
NA	VCCAUX	R1		
NA	VCCAUX	B16		
NA	VCCAUX	B1		
NA	VCCINT	N13		
NA	VCCINT	N4		
NA	VCCINT	M12		
NA	VCCINT	M5		
NA	VCCINT	E12		
NA	VCCINT	E5		
NA	VCCINT	D13		
NA	VCCINT	D4		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
4	IO_L95N_4/GCLK3S	W12		
4	IO_L95P_4/GCLK2P	Y12		
4	IO_L96N_4/GCLK1S	AA12		
4	IO_L96P_4/GCLK0P	AB12		
5	IO_L96N_5/GCLK7S	AA11		
5	IO_L96P_5/GCLK6P	Y11		
5	IO_L95N_5/GCLK5S	W11		
5	IO_L95P_5/GCLK4P	V11		
5	IO_L94N_5	U11		
5	IO_L94P_5/VREF_5	U10		
5	IO_L93N_5	AB10		
5	IO_L93P_5	AA10		
5	IO_L92N_5	Y10		
5	IO_L92P_5	W10		
5	IO_L91N_5	V10		
5	IO_L91P_5/VREF_5	V9		
5	IO_L54N_5	AB9	NC	
5	IO_L54P_5	AA9	NC	
5	IO_L52N_5	Y9	NC	
5	IO_L52P_5	W9	NC	
5	IO_L51N_5/VREF_5	AB8	NC	
5	IO_L51P_5	AA8	NC	
5	IO_L49N_5	Y8	NC	
5	IO_L49P_5	W8	NC	
5	IO_L24N_5	U9	NC	NC
5	IO_L24P_5	V8	NC	NC
5	IO_L22N_5	AB7	NC	NC
5	IO_L22P_5	AA7	NC	NC
5	IO_L21N_5/VREF_5	Y7	NC	NC
5	IO_L21P_5	W7	NC	NC
5	IO_L19N_5	AB6	NC	NC
5	IO_L19P_5	AA6	NC	NC
5	IO_L06N_5	Y6		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
5	IO_L06P_5	W6		
5	IO_L05N_5/VRP_5	V7		
5	IO_L05P_5/VRN_5	V6		
5	IO_L04N_5	AB5		
5	IO_L04P_5/VREF_5	AA5		
5	IO_L03N_5/D4/ALT_VRP_5	Y5		
5	IO_L03P_5/D5/ALT_VRN_5	W5		
5	IO_L02N_5/D6	AB4		
5	IO_L02P_5/D7	AA4		
5	IO_L01N_5/RDWR_B	Y4		
5	IO_L01P_5/CS_B	AA3		
6	IO_L01P_6	V5		
6	IO_L01N_6	U5		
6	IO_L02P_6/VRN_6	Y2		
6	IO_L02N_6/VRP_6	Y1		
6	IO_L03P_6	V4		
6	IO_L03N_6/VREF_6	V3		
6	IO_L04P_6	W2		
6	IO_L04N_6	W1		
6	IO_L06P_6	U4		
6	IO_L06N_6	U3		
6	IO_L19P_6	V2	NC	NC
6	IO_L19N_6	V1	NC	NC
6	IO_L21P_6	U2	NC	NC
6	IO_L21N_6/VREF_6	U1	NC	NC
6	IO_L22P_6	T5	NC	NC
6	IO_L22N_6	R5	NC	NC
6	IO_L24P_6	T4	NC	NC
6	IO_L24N_6	T3	NC	NC
6	IO_L43P_6	T2		
6	IO_L43N_6	T1		
6	IO_L45P_6	R4		
6	IO_L45N_6/VREF_6	R3		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
3	VCCO_3	V19		
3	VCCO_3	U25		
3	VCCO_3	U19		
3	VCCO_3	T18		
3	VCCO_3	R18		
3	VCCO_3	P18		
4	VCCO_4	AE20		
4	VCCO_4	AE17		
4	VCCO_4	W18		
4	VCCO_4	W17		
4	VCCO_4	V16		
4	VCCO_4	V15		
4	VCCO_4	V14		
5	VCCO_5	AE10		
5	VCCO_5	AE7		
5	VCCO_5	W10		
5	VCCO_5	W9		
5	VCCO_5	V13		
5	VCCO_5	V12		
5	VCCO_5	V11		
6	VCCO_6	Y2		
6	VCCO_6	V8		
6	VCCO_6	U8		
6	VCCO_6	U2		
6	VCCO_6	T9		
6	VCCO_6	R9		
6	VCCO_6	P9		
7	VCCO_7	N9		
7	VCCO_7	M9		
7	VCCO_7	L9		
7	VCCO_7	K8		
7	VCCO_7	K2		
7	VCCO_7	J8		
7	VCCO_7	G2		
NA	CCLK	AB21		
NA	PROG_B	C4		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
1	IO_L70N_1	B15	NC	
1	IO_L70P_1	C15	NC	
1	IO_L69N_1/VREF_1	E15	NC	
1	IO_L69P_1	F15	NC	
1	IO_L67N_1	G15	NC	
1	IO_L67P_1	H15	NC	
1	IO_L54N_1	B16		
1	IO_L54P_1	C16		
1	IO_L52N_1	D16		
1	IO_L52P_1	E16		
1	IO_L51N_1/VREF_1	F16		
1	IO_L51P_1	G16		
1	IO_L49N_1	A17		
1	IO_L49P_1	A19		
1	IO_L24N_1	B17		
1	IO_L24P_1	B18		
1	IO_L22N_1	C17		
1	IO_L22P_1	D17		
1	IO_L21N_1/VREF_1	F17		
1	IO_L21P_1	E17		
1	IO_L19N_1	A20		
1	IO_L19P_1	A21		
1	IO_L06N_1	B19		
1	IO_L06P_1	B20		
1	IO_L05N_1	C18		
1	IO_L05P_1	D18		
1	IO_L04N_1	C20		
1	IO_L04P_1/VREF_1	D20		
1	IO_L03N_1/VRP_1	D19		
1	IO_L03P_1/VRN_1	E19		
1	IO_L02N_1	E18		
1	IO_L02P_1	F18		
1	IO_L01N_1	H16		
1	IO_L01P_1	G17		
2	IO_L01N_2	D22		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
1	IO_L68P_1	G12	NC	
1	IO_L67N_1	A9	NC	
1	IO_L67P_1	A10	NC	
1	IO_L54N_1	E10		
1	IO_L54P_1	E11		
1	IO_L53N_1	H12		
1	IO_L53P_1	H11		
1	IO_L52N_1	D9		
1	IO_L52P_1	D10		
1	IO_L51N_1/VREF_1	C9		
1	IO_L51P_1	C8		
1	IO_L50N_1	F11		
1	IO_L50P_1	F10		
1	IO_L49N_1	B8		
1	IO_L49P_1	B9		
1	IO_L24N_1	E8		
1	IO_L24P_1	E9		
1	IO_L23N_1	G11		
1	IO_L23P_1	H10		
1	IO_L22N_1	B7		
1	IO_L22P_1	A7		
1	IO_L21N_1/VREF_1	D8		
1	IO_L21P_1	E7		
1	IO_L20N_1	G10		
1	IO_L20P_1	G9		
1	IO_L19N_1	A5		
1	IO_L19P_1	A6		
1	IO_L06N_1	C6		
1	IO_L06P_1	C7		
1	IO_L05N_1	F9		
1	IO_L05P_1	G8		
1	IO_L04N_1	B6		
1	IO_L04P_1/VREF_1	C5		
1	IO_L03N_1/VRP_1	D7		
1	IO_L03P_1/VRN_1	D6		
1	IO_L02N_1	F8		
1	IO_L02P_1	F7		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
3	IO_L83P_3	Y4	NC
3	IO_L82N_3	W11	NC
3	IO_L82P_3	V11	NC
3	IO_L81N_3/VREF_3	W8	NC
3	IO_L81P_3	Y8	NC
3	IO_L80N_3	W2	NC
3	IO_L80P_3	Y1	NC
3	IO_L79N_3	AA3	NC
3	IO_L79P_3	AB3	NC
3	IO_L78N_3	Y6	
3	IO_L78P_3	AA6	
3	IO_L77N_3	AA4	
3	IO_L77P_3	AB4	
3	IO_L76N_3	Y7	
3	IO_L76P_3	AA8	
3	IO_L75N_3/VREF_3	Y10	
3	IO_L75P_3	AA10	
3	IO_L74N_3	AA1	
3	IO_L74P_3	AB1	
3	IO_L73N_3	AA5	
3	IO_L73P_3	AB5	
3	IO_L72N_3	AA9	
3	IO_L72P_3	Y9	
3	IO_L71N_3	AA2	
3	IO_L71P_3	AB2	
3	IO_L70N_3	AB6	
3	IO_L70P_3	AC6	
3	IO_L69N_3/VREF_3	AD1	
3	IO_L69P_3	AC1	
3	IO_L68N_3	AC3	
3	IO_L68P_3	AD3	
3	IO_L67N_3	AC4	
3	IO_L67P_3	AD4	
3	IO_L54N_3	AB7	
3	IO_L54P_3	AC7	
3	IO_L53N_3	AC2	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	IO_L02P_5/D7	AG25	
5	IO_L01N_5/RDWR_B	AL30	
5	IO_L01P_5/CS_B	AM31	
6	IO_L01P_6	AE24	
6	IO_L01N_6	AD25	
6	IO_L02P_6/VRN_6	AJ30	
6	IO_L02N_6/VRP_6	AH30	
6	IO_L03P_6	AL32	
6	IO_L03N_6/VREF_6	AK32	
6	IO_L04P_6	AF25	
6	IO_L04N_6	AE25	
6	IO_L05P_6	AJ31	
6	IO_L05N_6	AK31	
6	IO_L06P_6	AH29	
6	IO_L06N_6	AG29	
6	IO_L19P_6	AG26	
6	IO_L19N_6	AF26	
6	IO_L20P_6	AL33	
6	IO_L20N_6	AK33	
6	IO_L21P_6	AJ32	
6	IO_L21N_6/VREF_6	AH32	
6	IO_L22P_6	AG28	
6	IO_L22N_6	AF28	
6	IO_L23P_6	AG30	
6	IO_L23N_6	AF30	
6	IO_L24P_6	AF29	
6	IO_L24N_6	AE29	
6	IO_L25P_6	AF27	
6	IO_L25N_6	AE27	
6	IO_L26P_6	AL34	
6	IO_L26N_6	AK34	
6	IO_L27P_6	AE28	
6	IO_L27N_6/VREF_6	AD28	
6	IO_L28P_6	AE26	
6	IO_L28N_6	AD26	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L09N_1/VREF_1	G9	NC	
1	IO_L09P_1	G10	NC	
1	IO_L08N_1	K13	NC	
1	IO_L08P_1	K12	NC	
1	IO_L07N_1	A4	NC	
1	IO_L07P_1	A5	NC	
1	IO_L06N_1	F8		
1	IO_L06P_1	E8		
1	IO_L05N_1	J11		
1	IO_L05P_1	K11		
1	IO_L04N_1	C5		
1	IO_L04P_1/VREF_1	C6		
1	IO_L03N_1/VRP_1	D6		
1	IO_L03P_1/VRN_1	D7		
1	IO_L02N_1	H10		
1	IO_L02P_1	J10		
1	IO_L01N_1	C4		
1	IO_L01P_1	B4		
2	IO_L01N_2	E3		
2	IO_L01P_2	D2		
2	IO_L02N_2/VRP_2	L13		
2	IO_L02P_2/VRN_2	M13		
2	IO_L03N_2	F4		
2	IO_L03P_2/VREF_2	E4		
2	IO_L04N_2	E1		
2	IO_L04P_2	D1		
2	IO_L05N_2	L12		
2	IO_L05P_2	M11		
2	IO_L06N_2	G6		
2	IO_L06P_2	F5		
2	IO_L07N_2	F2	NC	
2	IO_L07P_2	E2	NC	
2	IO_L08N_2	M12	NC	
2	IO_L08P_2	N12	NC	
2	IO_L09N_2	H6	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	IO_L10N_3	AK7	NC	
3	IO_L10P_3	AL7	NC	
3	IO_L09N_3/VREF_3	AK11	NC	
3	IO_L09P_3	AJ10	NC	
3	IO_L08N_3	AR1	NC	
3	IO_L08P_3	AT1	NC	
3	IO_L07N_3	AM5	NC	
3	IO_L07P_3	AN5	NC	
3	IO_L06N_3	AM7		
3	IO_L06P_3	AL8		
3	IO_L05N_3	AP3		
3	IO_L05P_3	AP4		
3	IO_L04N_3	AM6		
3	IO_L04P_3	AN6		
3	IO_L03N_3/VREF_3	AJ13		
3	IO_L03P_3	AH13		
3	IO_L02N_3/VRP_3	AR3		
3	IO_L02P_3/VRN_3	AT2		
3	IO_L01N_3	AP5		
3	IO_L01P_3	AR4		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	AV4		
4	IO_L01P_4/INIT_B	AU4		
4	IO_L02N_4/D0/DIN ⁽¹⁾	AM9		
4	IO_L02P_4/D1	AM10		
4	IO_L03N_4/D2/ALT_VRP_4	AT6		
4	IO_L03P_4/D3/ALT_VRN_4	AR6		
4	IO_L04N_4/VREF_4	AU6		
4	IO_L04P_4	AU5		
4	IO_L05N_4/VRP_4	AL10		
4	IO_L05P_4/VRN_4	AL11		
4	IO_L06N_4	AR8		
4	IO_L06P_4	AR7		
4	IO_L07N_4	AW5	NC	
4	IO_L07P_4	AW4	NC	
4	IO_L08N_4	AK12	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L95N_6	AA38		
6	IO_L96P_6	AA35		
6	IO_L96N_6	AA34		
7	IO_L96P_7	W34		
7	IO_L96N_7	Y34		
7	IO_L95P_7	W32		
7	IO_L95N_7	V32		
7	IO_L94P_7	W37		
7	IO_L94N_7	Y37		
7	IO_L93P_7/VREF_7	W35		
7	IO_L93N_7	Y35		
7	IO_L92P_7	W31		
7	IO_L92N_7	V31		
7	IO_L91P_7	V39		
7	IO_L91N_7	W39		
7	IO_L84P_7	V36		
7	IO_L84N_7	W36		
7	IO_L83P_7	W30		
7	IO_L83N_7	V30		
7	IO_L82P_7	V38		
7	IO_L82N_7	W38		
7	IO_L81P_7/VREF_7	V33		
7	IO_L81N_7	W33		
7	IO_L80P_7	W29		
7	IO_L80N_7	V29		
7	IO_L79P_7	T39		
7	IO_L79N_7	U39		
7	IO_L78P_7	U35		
7	IO_L78N_7	V35		
7	IO_L77P_7	W28		
7	IO_L77N_7	V28		
7	IO_L76P_7	U37		
7	IO_L76N_7	U38		
7	IO_L75P_7/VREF_7	U34		
7	IO_L75N_7	V34		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
7	IO_L96N_7	R27	
7	IO_L95P_7	R24	
7	IO_L95N_7	N24	
7	IO_L94P_7	T29	
7	IO_L94N_7	R29	
7	IO_L93P_7/VREF_7	R31	
7	IO_L93N_7	P31	
7	IO_L92P_7	R26	
7	IO_L92N_7	P26	
7	IO_L91P_7	R30	
7	IO_L91N_7	P30	
7	IO_L78P_7	R25	
7	IO_L78N_7	P25	
7	IO_L77P_7	R28	
7	IO_L77N_7	P28	
7	IO_L76P_7	N31	
7	IO_L76N_7	M31	
7	IO_L75P_7/VREF_7	R23	
7	IO_L75N_7	P23	
7	IO_L74P_7	N30	
7	IO_L74N_7	M30	
7	IO_L73P_7	P27	
7	IO_L73N_7	N27	
7	IO_L72P_7	P22	
7	IO_L72N_7	N22	
7	IO_L71P_7	N29	
7	IO_L71N_7	M29	
7	IO_L70P_7	N28	
7	IO_L70N_7	M28	
7	IO_L69P_7/VREF_7	N26	
7	IO_L69N_7	M26	
7	IO_L68P_7	L31	
7	IO_L68N_7	K31	
7	IO_L67P_7	M27	
7	IO_L67N_7	L27	
7	IO_L54P_7	N23	
7	IO_L54N_7	M23	
7	IO_L53P_7	L30	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	GND	D10	
NA	GND	D16	
NA	GND	D22	
NA	GND	D28	
NA	GND	E5	
NA	GND	E27	
NA	GND	F6	
NA	GND	F26	
NA	GND	G7	
NA	GND	G13	
NA	GND	G16	
NA	GND	G19	
NA	GND	G25	
NA	GND	H2	
NA	GND	H8	
NA	GND	H24	
NA	GND	H30	
NA	GND	J9	
NA	GND	J23	
NA	GND	K4	
NA	GND	K16	
NA	GND	K28	
NA	GND	N7	
NA	GND	N25	
NA	GND	P14	
NA	GND	P15	
NA	GND	P16	
NA	GND	P17	
NA	GND	P18	
NA	GND	R14	
NA	GND	R15	
NA	GND	R16	
NA	GND	R17	
NA	GND	R18	
NA	GND	T1	
NA	GND	T4	
NA	GND	T7	
NA	GND	T10	